

Normally – OFF Silicon Carbide Junction Transistor

V_{DS}	=	650 V
$V_{DS(ON)}$	=	1.4 V
I_D	=	8 A
R _{DS(ON)}	=	170 mΩ

Features

- 250 °C maximum operating temperature
- Temperature independent switching performance
- Gate oxide free SiC switch
- Suitable for connecting an anti-parallel diode
- · Positive temperature coefficient for easy paralleling
- · Low gate charge
- · Low intrinsic capacitance

Package

• RoHS Compliant





SMD0.5 / TO - 276 (Hermetic Package)

Advantages

- Low switching losses
- Higher efficiency
- High temperature operation
- · High short circuit withstand capability

Applications

- Down Hole Oil Drilling, Geothermal Instrumentation
- Hybrid Electric Vehicles (HEV)
- Solar Inverters
- Switched-Mode Power Supply (SMPS)
- Power Factor Correction (PFC)
- Induction Heating
- Uninterruptible Power Supply (UPS)
- Motor Drives

Maximum Ratings at T_j = 250 °C, unless otherwise specified

Parameter	Symbol	Conditions	Values	Unit
Drain – Source Voltage	$V_{ extsf{DS}}$	V _{GS} = 0 V	650	V
Continuous Drain Current	I _D	T _C = 158 °C	8	Α
Gate Peak Current	I _{GM}		5	Α
Reverse Gate – Source Voltage	V_{GS}		30	V
Reverse Drain – Source Voltage	$V_{ t DS}$		40	V
Power Dissipation	P _{tot}	T _C = 25 °C	11	W
Operating and Storage Temperature	T_{j},T_{stg}		-55 to 250	°C

Electrical Characteristics at T_i = 250 °C, unless otherwise specified

Parameter	Symbol	Conditions	Values			1114
		Conditions	min.	typ.	max.	Unit
On Characteristics						
		I _D = 8 A, I _G = 250 mA, T _j = 25 °C		1.4		
Drain – Source On Voltage	$V_{DS(ON)}$	$I_D = 8 \text{ A}, I_G = 500 \text{ mA}, T_j = 175 ^{\circ}\text{C}$		2.6		V
		I_D = 8 A, I_G = 500 mA, T_j = 250 °C		3.9		
	$R_{DS(ON)}$	I_D = 8 A, I_G = 250 mA, T_j = 25 °C		170		mΩ
Drain – Source On Resistance		I_D = 8 A, I_G = 500 mA, T_j = 175 °C		330		
		$I_D = 8 \text{ A}, I_G = 500 \text{ mA}, T_j = 250 ^{\circ}\text{C}$		550		
Gate Forward Voltage	$V_{GS(FWD)}$	$I_G = 500 \text{ mA}, T_j = 25 \text{ °C}$	<u> </u>	3		V
		$I_G = 500 \text{ mA}, T_j = 250 ^{\circ}\text{C}$		2.7		
DC Current Gain	β	$V_{DS} = 5 \text{ V}, I_D = 10 \text{ A}, T_j = 25 ^{\circ}\text{C}$		120		
		$V_{DS} = 5 \text{ V}, I_{D} = 10 \text{ A}, T_{i} = 250 ^{\circ}\text{C}$		80		

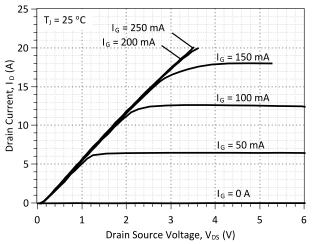
Off Characteristics

		$V_R = 650 \text{ V}, V_{GS} = 0 \text{ V}, T_j = 25 ^{\circ}\text{C}$	2.5	
Drain Leakage Current	I _{DSS}	$V_R = 650 \text{ V}, V_{GS} = 0 \text{ V}, T_j = 175 ^{\circ}\text{C}$	4	μΑ
		$V_{P} = 650 \text{ V}$, $V_{CS} = 0 \text{ V}$, $T_{i} = 250 \text{ °C}$	10	



Electrical Characteristics at T_i = 250 °C, unless otherwise specified

Parameter	Cumahal	Ol Conditions $\frac{\text{Values}}{\text{min.}}$ typ.	Values		- Unit	
	Symbol		max.			
Dynamic Characteristics						
Input Capacitance	C _{iss}	V 05VV 0V		720		pF
Output Capacitance	C _{oss}	$V_{DS} = 35 \text{ V}, V_{GS} = 0 \text{ V},$ $f = 1 \text{ MHz}, T_{vi} = 25 ^{\circ}\text{C}$		88		pF
Reverse Transfer Capacitance	C_{rss}	1 - 1 Williz, 1 _{Vj} - 25 C		88		pF
Switching Characteristics						
Turn On Delay Time	t _{d(on)}			11		ns
Rise Time	t _r	$V_{DD} = 400 \text{ V}, I_D = 10 \text{ A},$		28		ns
Turn Off Delay Time	$t_{\sf d(off)}$	$R_{G(on)} = R_{G(off)} = 32 \Omega,$		76		ns
Fall Time	t _f	$V_{GS} = -8/15 \text{ V}, T_j = 175 \text{ °C}$		38		ns
Turn-On Energy Per Pulse	E _{on}	Refer to Figure 10 for gate drive current waveforms		34		μJ
Turn-Off Energy Per Pulse	E_{off}			64		μJ
Total Switching Energy	E_{ts}			98		μJ
Turn On Delay Time	$t_{d(on)}$			12		ns
Rise Time	t _r	V _{DD} = 400 V. I _D = 10 A.		30		ns
Turn Off Delay Time	$t_{d(off)}$	$R_{G(on)} = R_{G(off)} = 32 \Omega$, $V_{GS} = -8/15 \text{ V}$, $T_{j} = 250 ^{\circ}\text{C}$ Refer to Figure 10 for gate drive current waveforms		73		ns
Fall Time	t _f			58		ns
Turn-On Energy Per Pulse	E _{on}			43		μJ
Turn-Off Energy Per Pulse	E_{off}			82		μJ
Total Switching Energy	E_ts			125		μJ
Thermal Characteristics						
Thermal resistance, junction - case	R_{thJC}			1		°C/W





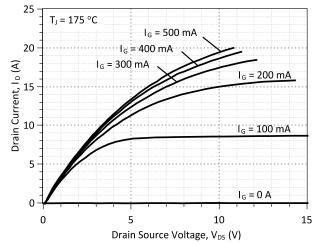


Figure 2: Typical Output Characteristics at 175 °C



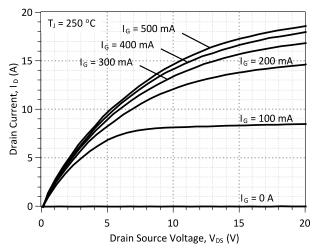


Figure 3: Typical Output Characteristics at 250 °C

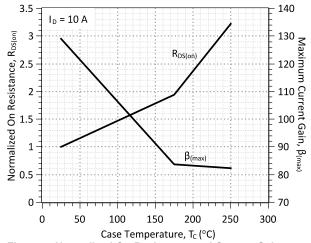


Figure 5: Normalized On-Resistance and Current Gain vs. Temperature

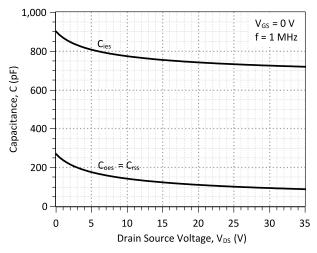


Figure 7: Typical Capacitance vs Drain-Source Voltage

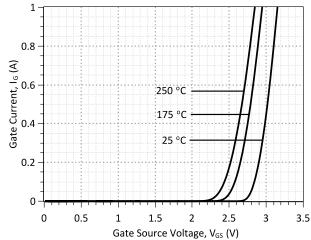


Figure 4: Typical Gate Source I-V Characteristics vs.
Temperature

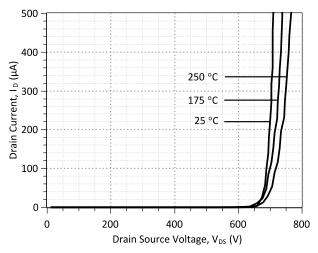


Figure 6: Typical Blocking Characteristics

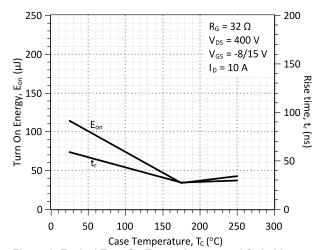


Figure 8: Typical Turn On Energy Losses and Switching Times vs. Temperature



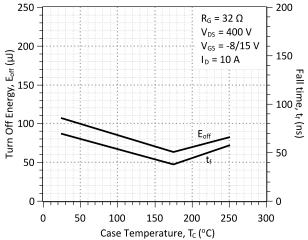


Figure 9: Typical Turn Off Energy Losses and Switching Times vs. Temperature

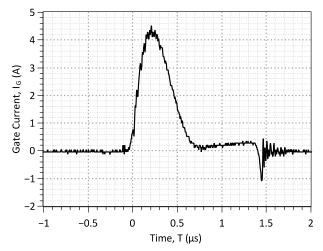
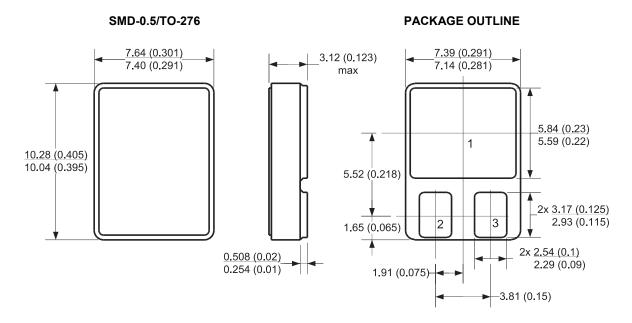


Figure 10: Typical Gate-Source Switching Waveforms

Package Dimensions:



- 1. CONTROLLED DIMENSION IS INCH. DIMENSION IN BRACKET IS MILLIMETER.
 2. DIMENSIONS DO NOT INCLUDE END FLASH, MOLD FLASH, MATERIAL PROTRUSIONS



Revision History					
Date	Revision	Comments	Supersedes		
2012/08/24	0	Initial release			

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SPICE Model Parameters

Copy the following code into a SPICE software program for simulation of the 2N7638-GA device.

```
MODEL OF GeneSiC Semiconductor Inc.
     $Revision: 1.0
     $Date: 06-SEP-2013
    GeneSiC Semiconductor Inc.
     43670 Trade Center Place Ste. 155
    Dulles, VA 20166
    http://www.genesicsemi.com/index.php/sic-products/sjt
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* These models are provided "AS IS, WHERE IS, AND WITH NO WARRANTY
* OF ANY KIND EITHER EXPRESSED OR IMPLIED, INCLUDING BUT NOT LIMITED
* TO ANY IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A
* PARTICULAR PURPOSE."
* Models accurate up to 2 times rated drain current.
.model 2N7638 NPN
+ IS
       3.73E-46
+ ISE
          5.50E-28
+ EG
          3.2
+ BF
         103
+ BR
         0.55
         900
+ IKF
+ NF
         2.021
+ NE
+ RB
         0.26
+ RE
         0.1
+ RC
         0.09
         2.77E-10
+ CJC
+ VJC
         3.023103628
+ MJC
          0.460762158
+ CJE
         8.23E-10
+ VJE
         2.945448229
        0.498044294
+ MJE
+ XTI
         3
          -0.35
+ XTB
          1.20E-02
+ TRC1
+ VCEO
         800
+ ICRATING 8
+ MFG GeneSiC Semiconductor
```

* End of 2N7638-GA SPICE Model